



DTA (R2-ONLY SERIES)

PNP PRE-BIASED SMALL SIGNAL SURFACE MOUNT TRANSIS

Obsolete Part Number	Alternative Part Number
DDTA114GKA	DDTA114GCA
DDTA115GKA	DDTA115GCA
DDTA124GKA	DDTA124GCA
DDTA144GKA	DDTA144GCA

Features

- Epitaxial Planar Die Construction
- Complementary NPN Types Available (DDTC)
- Built-In Biasing Resistor, R2 only
- Lead Free/RoHS Compliant (Note 2)
- "Green" Device Note 3 & 4

Mechanical Data

- Case: SC-59
- Case Material: Molded Plastic, "Green" Molding Compound, Note 4. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals: Solderable per MIL-STD-202, Method 208
- Lead Free Plating (Matte Tin Finish annealed over Copper leadframe).
- Terminal Connections: See Diagram
- Marking Information: See Table Below & Page 3
- Ordering Information: See Page 3
- Weight: 0.008 grams (approximate)

P/N	R2 (NOM)	Type Code
DDTA114GKA	10KΩ	P26
DDTA124GKA	22ΚΩ	P27
DDTA144GKA	47ΚΩ	P28
DDTA115GKA	100KΩ	P29



SC-59									
Dim	Min	Мах							
Α	0.35	0.50							
В	1.50	1.70							
С	2.70	3.00							
D	0.95								
G	1.90								
Н	2.90	3.10							
J	0.013	0.10							
К	1.00	1.30							
L	0.35	0.55							
М	0.10	0.20							
α	0°	8°							
All Dimensions in mm									

Maximum Ratings $@T_A = 25^{\circ}C$ unless otherwise specified

Characteristic	Symbol	Value	Unit	
Collector-Base Voltage	V _{CBO}	-50	V	
Collector-Emitter Voltage	V _{CEO}	-50	V	
Emitter-Base Voltage	V _{EBO}	-5	V	
Collector Current	I _C (Max)	-100	mA	
Power Dissipation	Pd	200	mW	
Thermal Resistance, Junction to Ambient Air (Note 1)	$R_{ ext{ heta}JA}$	625	°C/W	
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	٥C	

1. Mounted on FR4 PC Board with recommended pad layout at http://www.diodes.com/datasheets/ap02001.pdf.

2. No purposefully added lead.

3. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com/products/lead free/index.php.

Product manufactured with Date Code 0627 (week 27, 2006) and newer are built with Green Molding Compound. Product manufactured prior to Date Code 0627 are built with Non-Green Molding Compound and may contain Halogens or Sb2O3 Fire Retardants. 4.

Notes:



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Electrical Characteristics @T_A = 25°

CS @ $T_A = 25^{\circ}C$ unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
Collector-Base Breakdown Voltage		BV _{CBO}	-50			V	I _C = -50μA
Collector-Emitter Breakdown Voltag	e	BV _{CEO}	-50			V	I _C = -1mA
Emitter-Base Breakdown Voltage		BV _{EBO}	5		_	V	I _E = -720μΑ, DDTA114GKA I _E = -330μΑ, DDTA124GKA I _E = -160μΑ, DDTA144GKA I _E = -72μΑ, DDTA115GKA
Collector Cutoff Current		I _{CBO}			-0.5	μA	V _{CB} = -50V
Emitter Cutoff Current	DDTA114GKA DDTA124GKA DDTA144GKA DDTA115GKA	I _{EBO}	-300 -140 -65 -30	_	-580 -260 -130 -58	μΑ	V _{EB} = -4V
Collector-Emitter Saturation Voltage		V _{CE(sat)}	_	_	-0.3	V	I _C = -10mA, I _B = -0.5mA
DC Current Transfer Ratio	DDTA114GKA DDTA124GKA DDTA144GKA DDTA115GKA	h _{FE}	30 56 68 82	_	_	_	I _C = -5mA, V _{CE} = -5V
Bleeder Resistor (R ₂) Tolerance		ΔR_2	-30		+30	%	
Gain-Bandwidth Product*	n-Bandwidth Product [*] f_T — 250 — MHz V_{CE} = -10V, I_E = 5mA, f =			V _{CE} = -10V, I _E = 5mA, f = 100MHz			

* Transistor - For Reference Only

Typical Curves – DDTA114KA



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Ordering Information (Note 4 & 5)

Device	Packaging	Shipping			
DDTA114GKA-7-F	SC-59	3000/Tape & Reel			
DDTA124GKA-7-F	SC-59	3000/Tape & Reel			
DDTA144GKA-7-F	SC-59	3000/Tape & Reel			
DDTA115GKA-7-F	SC-59	3000/Tape & Reel			

Notes: 5. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information



PXX = Product Type Marking Code, See Table on Page 1 YM = Date Code Marking Y = Year ex: T = 2006 M = Month ex: 9 = September

Date Code Key

Year	2002	2003	2004	2005	200	6 20	07	20	800	2009	2010	2011	2012
Code	Ν	Р	R	S	Т	l	J		V	W	Х	Y	Z
Month	Jan	Feb	Mar	Apr	Мау	Jun	J	ul	Aug	l Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6		7	8	9	0	Ν	D





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